WINSTAR Display

OLED SPECIFICATION

Model No:

WEO012864JLPP3N00000

SPECIFICATION Version: E



APPROVED BY:

(FOR CUSTOMER USE ONLY)

SALES BY	APPROVED BY CHECKED BY	PREPARED BY
	R	
RELEASE DATE:		

APPROVAL FOR SPECIFICATIONS ONLY

APPROVAL FOR SPECIFICATIONS AND SAMPLE

MODEL NO:

REC	RECORDS OF REVI		DOC. FIRST ISSUE
VERSION	DATE	REVISED PAGE NO.	SUMMARY
0	2015/01/12		First release
A	2015/06/30		Remove reference spec.
В	2015/11/16		Modify Life time.
С	2016/03/23		Modify Static electricity test
D	2016/11/22		Add FPC bending rule
E	2018/05/10		 Added 3.1 Application Recommendations. Add section 4 interface pin15&pin17 description. Modify section 5 storage temperature maximum value. Modify section 6 50% check board operating current and added initial setting.

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1.Module Classification Information \underline{W} \underline{E} \underline{O} $\underline{012864}$ \underline{J} \underline{L} \underline{P} $\underline{3}$ \underline{N} $\underline{0}$ $\underline{0$

1	Brand : WINST	AR DISPLAY CORPORA	TION			
2	E : OLED					
		H : COB Character	G : COB Graphic			
2	Dianley Type	O : COG	F : COG + FR	XO		
3	Display Type	P : COG + FR + PCB	X : TAB			
		A : COG + PCB				
4	Dot Matrix : 12	28 * 64				
5	Serials code		C V			
		A : Amber	R : Red	C : Full Color		
6	Emitting Color	B : Blue	W : White			
0	Emitting Color	G : Green	L : Yellow			
		S : Sky Blue	X : Dual Color			
7	Polarizer		P: With Polarizer; N: Without Polarizer			
		A : Anti-glare Polarize				
8	Display Mode					
9	Driver Voltage	3:3.0~3.3V;5:5				
10	Touch Panel	N: Without touch panel	el; T: With touch panel			
		0 : Standard				
		1 : Daylight Readable				
11	Product type	2: Transparent OLED				
		3 · Flexible OLED (FO	LED)			
		4: OLED Lighting				
		0 : Standard				
12	Inspection	2 : Special grade				
	Grade	5	C : Automotive grade			
		Y : Consumer grade				
13	Option		PC ; H : Hot bar FPC; D :	Demo Kit		
14	Serial No.	Serial number(00~ZZ)				

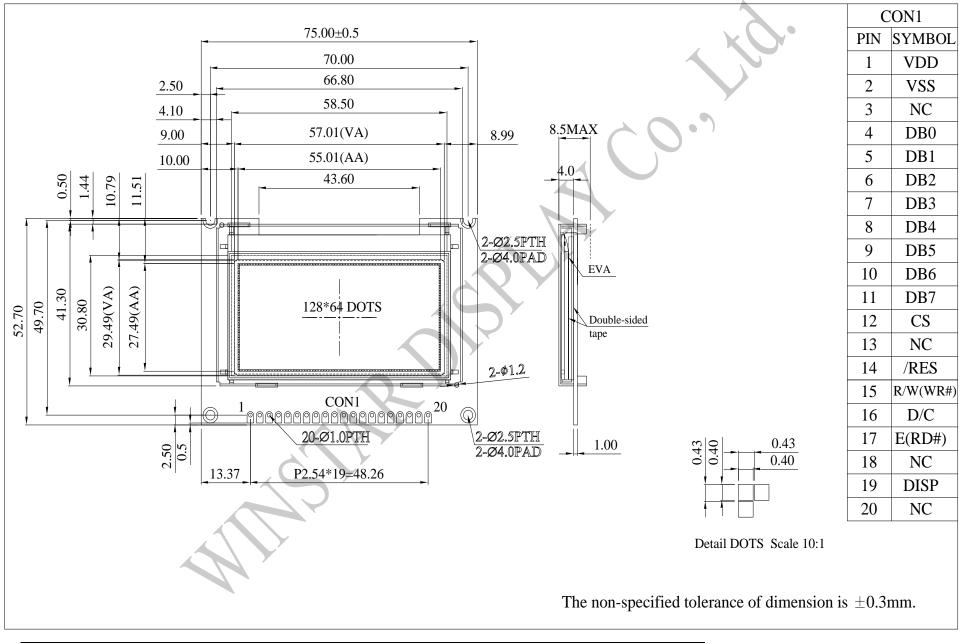
2.General Specification

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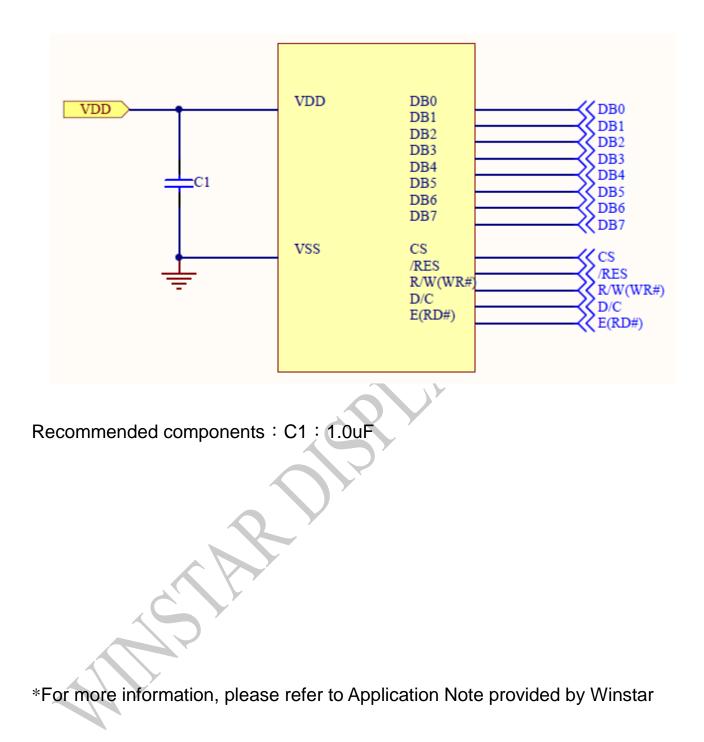
ltem	Dimension	Unit			
Dot Matrix	128 x 64	_			
Module dimension	75.0 × 52.7 × 8.5	mm			
Active Area	55.01 × 27.49	mm			
Pixel Size	0.40 × 0.40	mm			
Pixel Pitch	0.43 × 0.43	mm			
Display Mode	Passive Matrix	0.			
Display Color	Monochrome (Yellow)				
Drive Duty	1/64 Duty				
IC	SSD1309				
Interface	8080				
Size	2.42 inch				

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3. Contour Drawing & Block Diagram



3.1 Application recommendations



4. Interface Pin Function

No.	Symbol	Function
1	VDD	Power supply pin for core logic operation.
2	VSS	Ground.
3	NC	No connection
4~11	D0~D7	Data bus.
12	CS	This pin is the chip select input connecting to the MCU. The chip is enabled for MCU communication only when CS# is pulled LOW (active LOW).
13	NC	No connection
14	/RES	This pin is reset signal input. When the pin is pulled LOW, initialization of the chip is executed. Keep this pin pull HIGH during normal operation.
15	R/W(WR#)	This pin is read / write control input pin connecting to the MCU interface. When 8080 interface mode is selected, this pin will be the Write (WR#) input. Data write operation is initiated when this pin is pulled LOW and the chip is selected.
16	D/C	This pin is Data/Command control pin connecting to the MCU.
17	E(RD#)	This pin is MCU interface input. When 8080 interface mode is selected, this pin receives the Read (RD#) signal. Read operation is initiated when this pin is pulled LOW and the chip is selected.
18	NC	No connection
19	DISP	Display off
20	NC	No connection

* 80 Series Interface is default

5.Absolute Maximum Ratings

Parameter	Symbol	Min	Max	Unit	Notes
Supply Voltage for Logic	VDD	-0.3	4	V	_
Operating Temperature	TOP	-40	+80	°C	_
Storage Temperature	TSTG	-40	+85	°C	~ •

Maximum ratings are those values beyond which damages to the device may occur. Functional operation should be restricted to the limits in the Electrical Characteristics tables or Pin Description section.

This device may be light sensitive. Caution should be taken to avoid exposure of this device to any light source during normal operation. This device is not radiation protected.

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6.Electrical Characteristics

6.1 DC Electrical Characteristics

Item	Symbol	Condition	Min	Тур	Max	Unit
Supply Voltage for Logic	VDD		2.8	3.0	3.3	V
High Level Input	VIH	_	0.8×VDD	_	XQ	V
Low Level Input	VIL	_	_	_	0.2×VDD	V
High Level Output	VOH	_	0.9×VDD		· -	V
Low Level Output	VOL	_	- (0	0.1×VDD	V
50% Check Board operating Current	IDD	VDD =3.0V		135	200	mA

6.2 Initial code

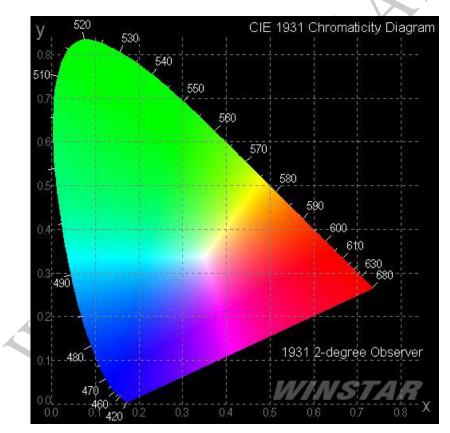
Void initial(void){

```
Write command(0xAE); // Display Off
Write command(0xAD); // Master Configuration
Write command(0x8E); // Select external VCC supply
Write_command(0xA8); // Select Multiplex Ratio
Write command(0x3F); // Default => 0x3F (1/64 Duty) 0x1F(1/32 Duty)
Write_command(0xD3); //Setting Display Offset
Write_command(0x00); //00H Reset
Write command(0x10); //Set Column Address MSB
Write_command(0x00); //Set Column Address LSB
Write command(0x40); //Set Display Start Line
Write_command(0x00); //;Set Memory Addressing Mode Default => 0x02
                      //0x00 => Horizontal Addressing Mode
Write command(0xA6); //Set Normal Display
Write_command(0xDB); //Set Deselect Vcomh level
Write command(0x3C); //~0.83xVCC
Write command(0xA4); //Entire Display ON
Write_command(0x81); //Set Contrast Control for Bank 0
Write command(0x6E);
Write_command(0xD5); //SET DISPLAY CLOCK
Write_command(0xF0); //105HZ
Write command(0xD8); //Select Area color ON/OFF
Write_command(0x05); //MONO Mode and Low Power display Mode
Write command(0xDA); //Set COM Hardware Configuration
Write_command(0x12); //Alternative COM Pin
Write _command(0xD9); //Set Pre-Charge period
Write_command(0xF2); //Refer to SPEC 34PAGE
Write command(0xFF); //
Write command(0xAF); // Display ON
Write command(0xC0);
                         //0xC8 (0x08) => Scan from COM63 to 0
Write_command(0xA0);
                        //0xA1 (0x01) => Column Address 0 Mapped to SEG131
```

}

7.Optical Characteristics

ltem	Symbol	Condition	Min	Тур	Max	Unit
	(∨)θ	_	160	_	_	deg
View Angle	(H)φ	_	160	_	1	deg
Contrast Ratio	CR	Dark	2000:1	_	x	•
Deenenee Time	T rise	_	_	10		μs
Response Time	T fall	_		10	_	μs
Display with 50%	Display with 50% check Board Brightness		80	100	_	cd/m2
CIEx(Yellow)		(CIE1931)	0.45	0.47	0.49	—
CIEy(Yellow)		(CIE1931)	0.48	0.50	0.52	



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8.OLED Lifetime

ITEM	Conditions	Min	Тур	Remark
Operating Life Time	Ta=25℃ / Initial 50% check board brightness Typical Value	50,000 Hrs	_	Note

Notes:

- 1. Life time is defined the amount of time when the luminance has decayed to <50% of the initial value.
- 2. This analysis method uses life data obtained under accelerated conditions to extrapolate an estimated probability density function (*pdf*) for the product under normal use conditions.
- 3. Screen saving mode will extend OLED lifetime.

9.Reliability

Content of Reliability Test

Test Item	Content of Test	Test Condition	Applicable Standard
High Temperature storage	Endurance test applying the high storage temperature for a long time.	85°C 240hrs	- >
Low Temperature storage	Endurance test applying the low storage temperature for a long time.	-40°C 240hrs	-
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	80°C 240hrs	
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-40°C 240hrs	
High Temperature/ Humidity Storage	Endurance test applying the high temperature and high humidity storage for a long time.	60°C,90%RH 240hrs	
High Temperature/ Humidity Operation	Endurance test applying the high temperature and high humidity Operation for a long time.	60°C,90%RH 120hrs	
Temperature Cycle	Endurance test applying the low and high temperature cycle. -40°C 25°C 80°C 30min 5min 30min	-40°C /80°C 30 cycles	
Mechanical Te	st		
Vibration test	Endurance test applying the vibration during transportation and using.	Frequency:10~55Hz amplitude:1.5mm Time:0.5hrs/axis Test axis:X,Y,Z	
Others			
Static electricity test	Endurance test applying the electric stress to the terminal.	Air Discharge model ±4kv,10 times	

*** Supply voltage for OLED system =Operating voltage at 25°C

Test and measurement conditions

- 1. All measurements shall not be started until the specimens attain to temperature stability. After the completion of the described reliability test, the samples were left at room temperature for 2 hrs prior to conducting the failure test at 23±5°C; 55±15% RH.
- 2. All-pixels-on is used as operation test pattern.
- 3. The degradation of Polarizer are ignored for High Temperature storage, High Temperature/ Humidity Storage, Temperature Cycle

Evaluation criteria

- 1. The function test is OK.
- 2. No observable defects.
- 3. Luminance: > 50% of initial value.
- 4. Current consumption: within \pm 50% of initial value.

APPENDIX:

RESIDUE IMAGE

Because the pixels are lighted in different time, the luminance of active pixels may reduce or differ from inactive pixels. Therefore, the residue image will occur. To avoid the residue image, every pixel needs to be lighted up uniformly.



10.Inspection specification

Inspection Standard:

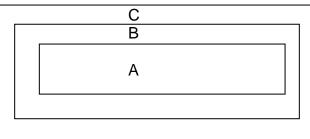
MIL-STD-105E table normal inspection single sample level II.

Definition

1 Major defect : The defect that greatly affect the usability of product.

2 Minor defect : The other defects, such as cosmetic defects, etc.

Definition of inspection zone:



Zone A: Active Area

Zone B: Viewing Area except Zone A

Zone C: Outside Viewing Area

Note: As a general rule, visual defects in Zone C are permissible, when it is no trouble of quality and assembly to customer`s product.

Inspection Methods

- 1 The general inspection : Under fluorescent light illumination: 750~1500 Lux, about 30cm viewing distance, within 45° viewing angle, under 25±5°C.
- 2 The luminance and color coordinate inspection : By SR-3 or BM-7 or the equal equipments, in the dark room, under 25±5°C.

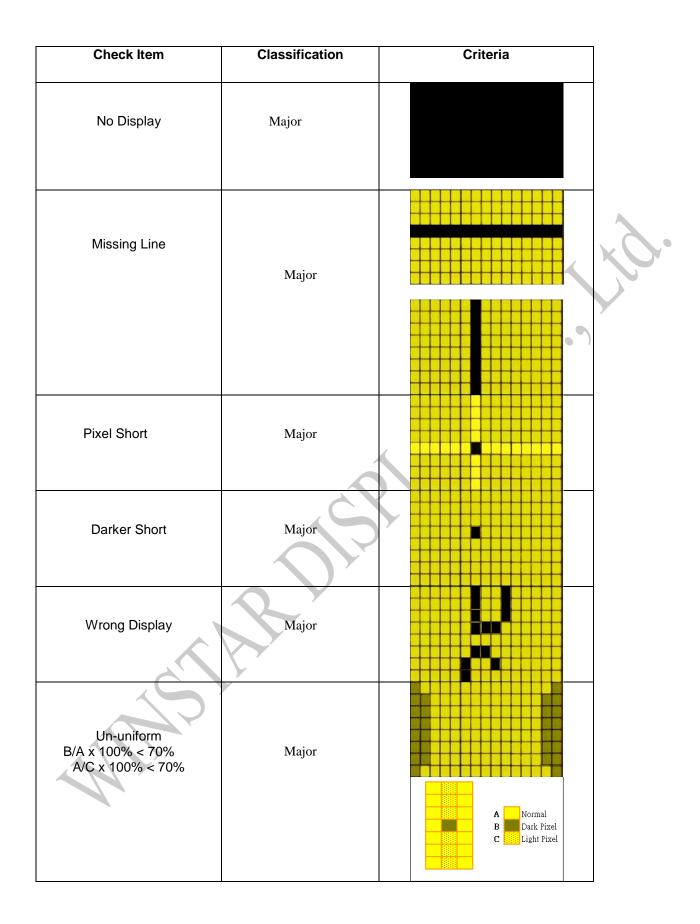
NO	ltem	Criterion	AQL
01	Electrical Testing	 1.1 Missing vertical, horizontal segment, segment contrast defect. 1.2 Missing character, dot or icon. 1.3 Display malfunction. 1.4 No function or no display. 1.5 Current consumption exceeds product specifications. 1.6 OLED viewing angle defect. 1.7 Mixed product types. 1.8 Contrast defect. 	0.65
02	Black or white spots on OLED (display only)	 2.1 White and black spots on display ≤ 0.25mm, no more than three white or black spots present. 2.2 Densely spaced: No more than two spots or lines within 3mm. 	2.5

NO	Item	Criterion				AQL
	OLED black spots, white	3.1 Round type : As following drawing Φ=(x + y) / 2	SIZE	Acceptable QTY	Zone	
	spots, contaminati	$ \begin{array}{c} \begin{array}{c} \begin{array}{c} \begin{array}{c} \\ \end{array} \end{array} \end{array} \\ \begin{array}{c} \end{array} \end{array} \\ \begin{array}{c} \end{array} \\ \begin{array}{c} \end{array} \end{array} \\ \begin{array}{c} \end{array} \\ \end{array} \\ \begin{array}{c} \end{array} \end{array} \\ \begin{array}{c} \end{array} \\ \begin{array}{c} \end{array} \\ \end{array} \\ \end{array} \\ \begin{array}{c} \end{array} \\ \end{array} \\ \begin{array}{c} \end{array} \\ \end{array} \\ \end{array} \\ \begin{array}{c} \end{array} \\ \end{array} \\ \end{array} \\ \end{array} \\ \begin{array}{c} \end{array} \\ \end{array} \\ \end{array} \\ \end{array} \\ \begin{array}{c} \end{array} \\ \end{array} $	Ф≦0.10	Accept no dense	A+ B,	2.5
	on (non- display)	→∩⊶-±	0.10<Φ≦0.20	2	A+ B	
			$0.20 \! < \! \Phi \! \le \! 0.25$	1	A+ B	
			0.25<Φ	0	A+ B	
		3.2 Line type : (As	following drawing			
03				10.		0.5
		Lengt	n Width	Acceptable Q TY	Zone	2.5
			W≦0.02	Accept no dense	A+B	
		L≦3.(A+B	
		L≦2.5)5	A+B	
			0.05 <w< td=""><td>As round type</td><td></td><td></td></w<>	As round type		
		If bubbles are	Size Φ	Acceptable Q TY	Zone	
		visible, judge	Φ≦0.20	Accept no dense	A+B	
		using black spot	0.20<Φ≦0.50	3	A+B	
	Polarizer	specifications, not easy to find,	$0.50 < \Phi \le 1.00$	2	A+B	0.5
04	bubbles	must check in	1.00<Ф	0	A+B	2.5
		specify	Total Q TY	3		
		direction.				
05	Scratches	Follow NO.3 OLEI	D black spots, whi	te spots, contamina	tion.	

NO	Item	Criterion	AQL
06	Chipped glass	Symbols Define: x: Chip lengthy: Chip widthz: Chip thicknessk: Seal widtht: Glass thicknessa: OLED side lengthL: Electrode pad length: 6.1 General glass chip : 6.1.1 Chip on panel surface and crack between panels: x x y k x x y k z Chip thickness y : Chip width z : Chip thickness y : Chip width x : Chip length $Z \leq 1/2t$ Not over viewing area $x \leq 1/8a$ $1/2t < z \leq 2t$ Not exceed $1/3k$ $x \leq 1/8a$ z : Chip thickness y : Chip width x : Chip length $z \leq 1/2t$ Not over viewing area $x \leq 1/8a$ $1/2t < z \leq 2t$ Not exceed $1/3k$ $x \leq 1/8a$ $1/2t < z \leq 2t$ Not over viewing area $x \leq 1/8a$ $1/2t < z \leq 2t$ Not over viewing area $x \leq 1/8a$ $1/2t < z \leq 2t$ Not exceed $1/3k$ $x \leq 1/8a$ $1/2t < z \leq 2t$ Not exceed $1/3k$ $x \leq 1/8a$ $1/2t < z \leq 2t$ Not exceed $1/3k$ $x \leq 1/8a$ 0 If there are 2 or more chips, x is the total length of each chip.	2.5
06	Glass crack	Symbols : x: Chip length y: Chip width z: Chip thickness k: Seal width t: Glass thickness a: OLED side length L: Electrode pad length 6.2 Protrusion over terminal : 6.2.1 Chip on electrode pad : V L y: Chip width x: Chip length y: Chip width x: Chip length y $\leq 0.5mm$ x $\leq 1/8a$ 0 < z $\leq t$	2.5

NO	Item	Criterion	AQL		
		6.2.2 Non-conductive portion:			
06	Glass crack	y z z y z z z z z			
		y: Chip width x: Chip length z: Chip thickness			
		y≤ L x≤1/8a 0 < z ≤ t	2.5		
		$y: width \qquad x: length \\ y \leq 1/3L \qquad x \leq a$			
07	Cracked glass	The OLED with extensive crack is not acceptable.	2.5		
08	Backlight elements	 8.1 Illumination source flickers when lit. 8.2 Spots or scratched that appear when lit must be judged. Using OLED spot, lines and contamination standards. 	0.65 2.5		
		8.3 Backlight doesn't light or color wrong.	0.65		
09	Bezel	 9.1 Bezel may not have rust, be deformed or have fingerprints, stains or other contamination. 9.2 Bezel must comply with job operifications. 	2.5		
~	PCB, COB	 9.2 Bezel must comply with job specifications. 10.1 COB seal may not have pinholes larger than 0.2mm or contamination. 10.2 COB seal surface may not have pinholes through to the IC. 10.2 The beight of the COP should not exceed the beight. 	0.65 2.5 2.5		
		10.3 The height of the COB should not exceed the height indicated in the assembly diagram.10.4 There may not be more than 2mm of sealant outside the seal area on the PCB. And there should be no more than three places.	0.65 2.5		
10		10.5 No oxidation or contamination PCB terminals.	2.5		
		10.6 Parts on PCB must be the same as on the production characteristic chart. There should be no wrong parts, missing parts or excess parts.	0.65		
		10.7 The jumper on the PCB should conform to the product characteristic chart.	0.65		
		10.8 If solder gets on bezel tab pads, OLED pad, zebra pad or screw hold pad, make sure it is smoothed down.	2.5		
▶▶▶ \\//\\CTAD WE0012864II PP3N00000					

NO	Item	Criterion	AQL
11	Soldering	 11.1 No un-melted solder paste may be present on the PCB. 11.2 No cold solder joints, missing solder connections, oxidation or icicle. 11.3 No residue or solder balls on PCB. 11.4 No short circuits in components on PCB. 	2.5 2.5 2.5 0.65
12	General appearance	 12.1 No oxidation, contamination, curves or, bends on interface Pin (OLB) of TCP. 12.2 No cracks on interface pin (OLB) of TCP. 12.3 No contamination, solder residue or solder balls on product. 12.4 The IC on the TCP may not be damaged, circuits. 12.5 The uppermost edge of the protective strip on the interface pin must be present or look as if it cause the interface pin to sever. 12.6 The residual rosin or tin oil of soldering (component or chip component) is not burned into brown or black color. 12.7 Sealant on top of the ITO circuit has not hardened. 12.8 Pin type must match type in specification sheet. 12.9 OLED pin loose or missing pins. 12.10 Product packaging must the same as specified on packaging specification sheet. 12.11 Product dimension and structure must conform to product specification sheet. 	2.5 0.65 2.5 2.5 2.5 2.5 2.5 2.5 0.65 0.65 0.65 0.65



11.Precautions in use of OLED Modules

Modules

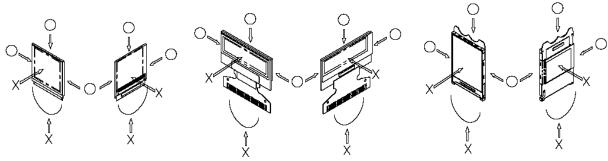
(1) Avoid applying excessive shocks to module or making any alterations or modifications to it.

- (2)Don't make extra holes on the printed circuit board, modify its shape or change the components of OLED display module.
- (3)Don't disassemble the OLED display module.
- (4)Don't operate it above the absolute maximum rating.
- (5)Don't drop, bend or twist OLED display module.
- (6)Soldering: only to the I/O terminals.
- (7)Storage: please storage in anti-static electricity container and clean environment.
- (8) It's pretty common to use "Screen Saver" to extend the lifetime and Don't use fix information for long time in real application.
- (9)Don't use fixed information in OLED panel for long time, that will extend "screen burn" effect time.
- (10)Winstar has the right to change the passive components, including R2and R3 adjust resistors. (Resistors, capacitors and other passive components will have different appearance and color caused by the different supplier.)
- (11)Winstar have the right to change the PCB Rev. (In order to satisfy the supplying stability, management optimization and the best product performance...etc, under the premise of not affecting the electrical characteristics and external dimensions, Winstar have the right to modify the version.)

11.1. Handling Precautions

- (1) Since the display panel is being made of glass, do not apply mechanical impacts such us dropping from a high position.
- (2) If the display panel is broken by some accident and the internal organic substance leaks out, be careful not to inhale nor lick the organic substance.
- (3) If pressure is applied to the display surface or its neighborhood of the OLED display module, the cell structure may be damaged and be careful not to apply pressure to these sections.
- (4) The polarizer covering the surface of the OLED display module is soft and easily scratched. Please be careful when handling the OLED display module.
- (5) When the surface of the polarizer of the OLED display module has soil, clean the surface. It takes advantage of by using following adhesion tape.
 - * Scotch Mending Tape No. 810 or an equivalent
 - Never try to breathe upon the soiled surface nor wipe the surface using cloth containing solvent such as ethyl alcohol, since the surface of the polarizer will become cloudy.
 - Also, pay attention that the following liquid and solvent may spoil the polarizer:
 - * Water
 - * Ketone
 - * Aromatic Solvents
- (6) Hold OLED display module very carefully when placing OLED display module into the System housing. Do not apply excessive stress or pressure to OLED display module. And, do not over bend the film with electrode pattern layouts.

These stresses will influence the display performance. Also, secure sufficient rigidity for the outer cases.



- (7) Do not apply stress to the LSI chips and the surrounding molded sections.
- (8) Do not disassemble nor modify the OLED display module.
- (9) Do not apply input signals while the logic power is off.
- (10) Pay sufficient attention to the working environments when handing OLED display modules to prevent occurrence of element breakage accidents by static electricity.
- * Be sure to make human body grounding when handling OLED display modules.
- * Be sure to ground tools to use or assembly such as soldering irons.
- * To suppress generation of static electricity, avoid carrying out assembly work under dry environments.
- * Protective film is being applied to the surface of the display panel of the OLED display module. Be careful since static electricity may be generated when exfoliating the protective film.

(11) Protection film is being applied to the surface of the display panel and removes the protection film before assembling it. At this time, if the OLED display module has been stored for a long period of time, residue adhesive material of the protection film may remain on the surface of the display panel after removed of the film. In such case, remove the residue material by the method introduced in the above Section 5.

(12) If electric current is applied when the OLED display module is being dewed or when it is placed under high humidity environments, the electrodes may be corroded and be careful to avoid the above.

11.2. Storage Precautions

(1) When storing OLED display modules, put them in static electricity preventive bags avoiding exposure to direct sun light nor to lights of fluorescent lamps. and, also, avoiding high temperature and high humidity environment or low temperature (less than 0°C) environments.

(We recommend you to store these modules in the packaged state when they were shipped from Winstar.

At that time, be careful not to let water drops adhere to the packages or bags nor let dewing occur with them.

(2) If electric current is applied when water drops are adhering to the surface of the OLED display module, when the OLED display module is being dewed or when it is placed under high humidity environments, the electrodes may be corroded and be careful about the above.

11.3. Designing Precautions

(1) The absolute maximum ratings are the ratings which cannot be exceeded for OLED display module, and if these values are exceeded, panel damage may be happen.

(2) To prevent occurrence of malfunctioning by noise, pay attention to satisfy the VIL and VIH specifications and, at the same time, to make the signal line cable as short as possible.
(3) We recommend you to install excess current preventive unit (fuses, etc.) to the power circuit (VDD). (Recommend value: 0.5A)

(4) Pay sufficient attention to avoid occurrence of mutual noise interference with the neighboring devices.

(5) As for EMI, take necessary measures on the equipment side basically.

(6) When fastening the OLED display module, fasten the external plastic housing section.

(7) If power supply to the OLED display module is forcibly shut down by such errors as taking out the main battery while the OLED display panel is in operation, we cannot guarantee the quality of this OLED display module.

* Connection (contact) to any other potential than the above may lead to rupture of the IC.

11.4. Precautions when disposing of the OLED display modules

1) Request the qualified companies to handle industrial wastes when disposing of the OLED display modules. Or, when burning them, be sure to observe the environmental and hygienic laws and regulations.

11.5. Other Precautions

- (1) When an OLED display module is operated for a long of time with fixed pattern may remain as an after image or slight contrast deviation may occur.
- Nonetheless, if the operation is interrupted and left unused for a while, normal state can be restored. Also, there will be no problem in the reliability of the module.
- (2) To protect OLED display modules from performance drops by static electricity rapture, etc., do not touch the following sections whenever possible while handling the OLED display modules.
- * Pins and electrodes
- * Pattern layouts such as the TCP & FPC
- (3) With this OLED display module, the OLED driver is being exposed. Generally speaking, semiconductor elements change their characteristics when light is radiated according to the principle of the solar battery. Consequently, if this OLED driver is exposed to light, malfunctioning may occur.
- * Design the product and installation method so that the OLED driver may be shielded from light in actual usage.
- * Design the product and installation method so that the OLED driver may be shielded from light during the inspection processes.
- (4) Although this OLED display module stores the operation state data by the commands and the indication data, when excessive external noise, etc. enters into the module, the internal status may be changed. It therefore is necessary to take appropriate measures to suppress noise generation or to protect from influences of noise on the system design.
- (5) We recommend you to construct its software to make periodical refreshment of the operation statuses (re-setting of the commands and re-transference of the display data) to cope with catastrophic noise.
- (6) Resistors, capacitors and other passive components will have different appearance and color caused by the different supplier.
- (7) Our company will has the right to upgrade and modify the product function.
- (8) The limitation of FPC and Film bending.

